

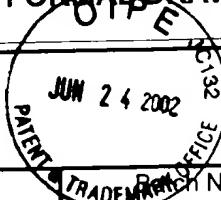
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TRANSMITTAL OF FORMAL DRAWINGS

Docket No.

Jin 210-33-6

In Re Application Of: S. Jin et al.



Serial No.

09/769,193

Filing Date

01/25/2001

TRADEMARK No.

Examiner

Jennifer Doan

Art Unit

2874

Invention: Resiliently Packaged MEMs Device and Method for Making Same

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Transmitted herewith are:

11 sheets of formal drawing(s) for this application.

Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

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FIG. 1A

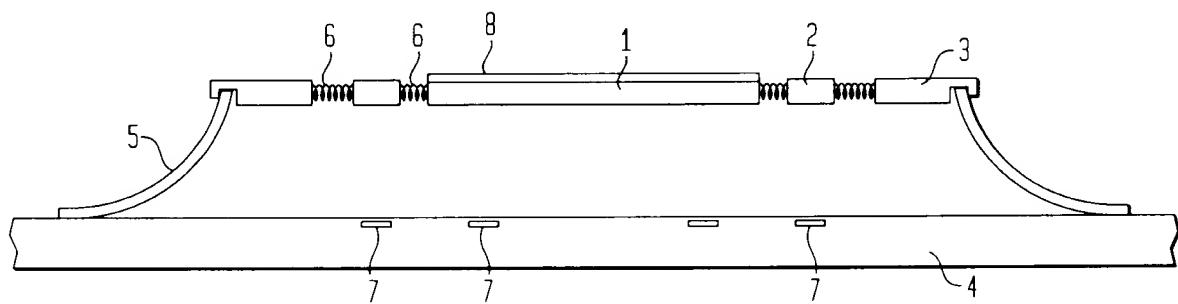


FIG. 1B

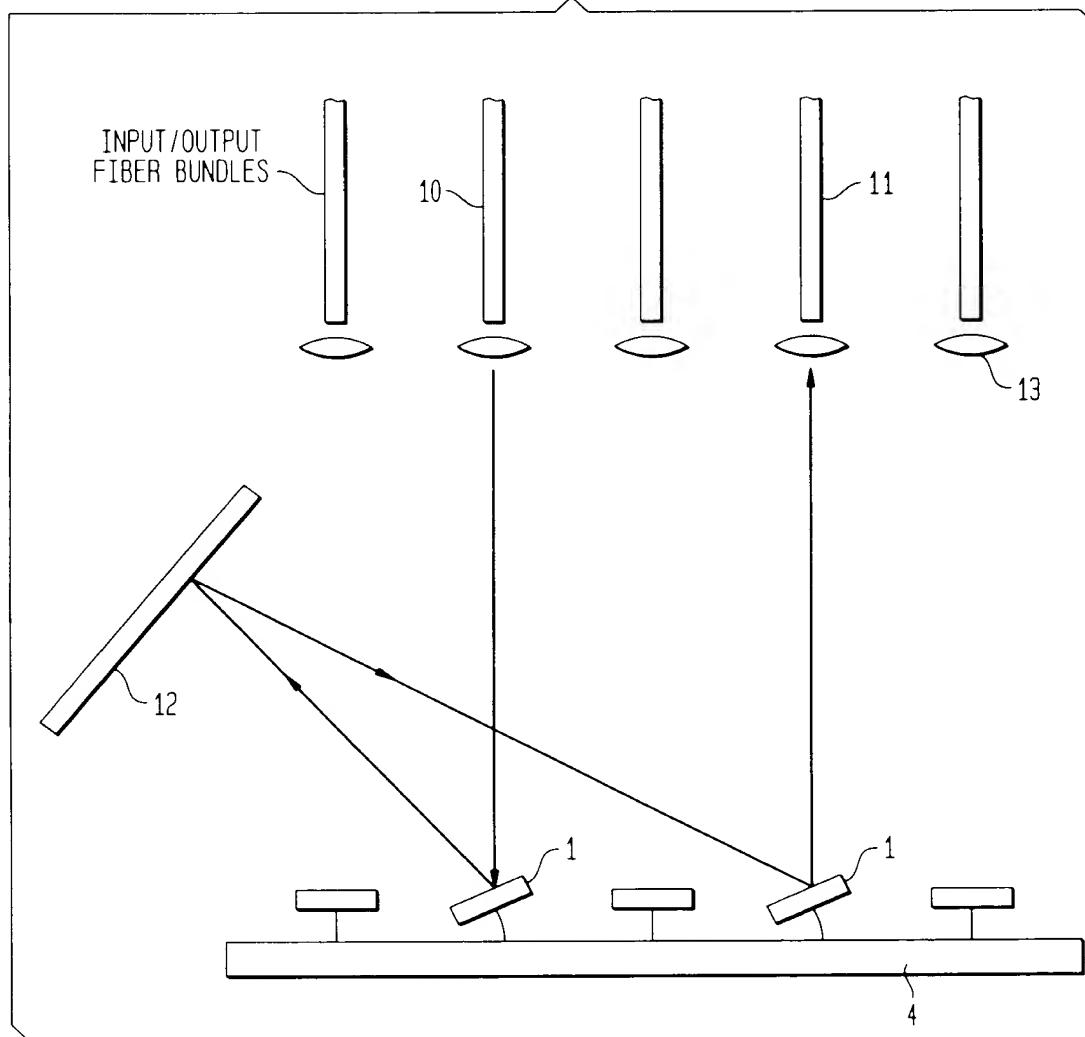
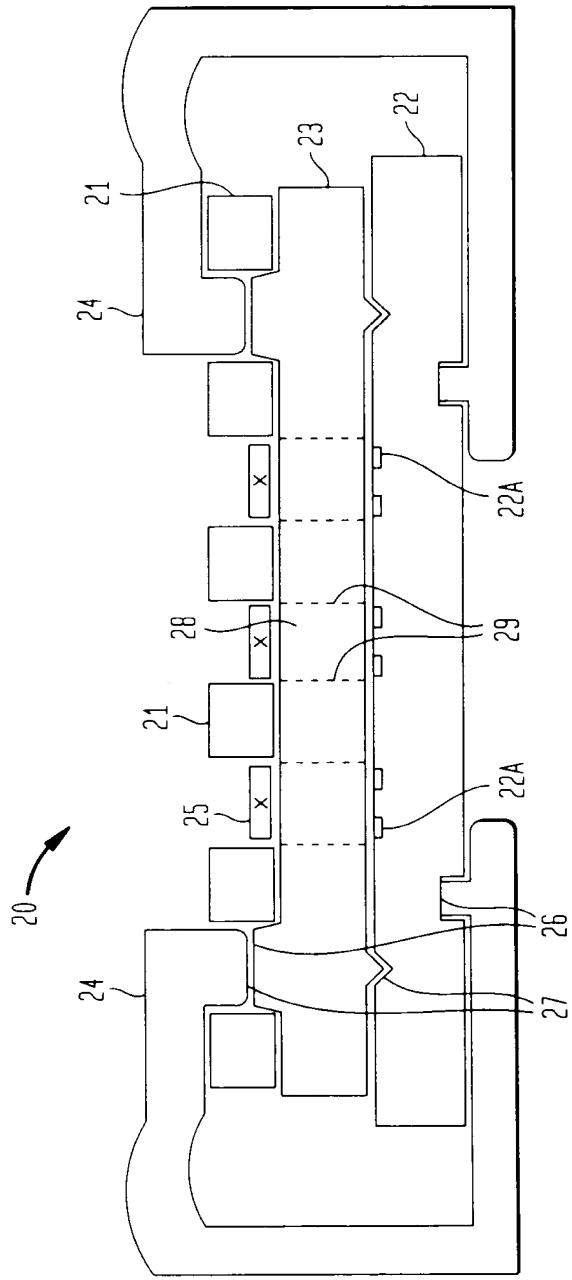


FIG. 2



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FIG. 3A

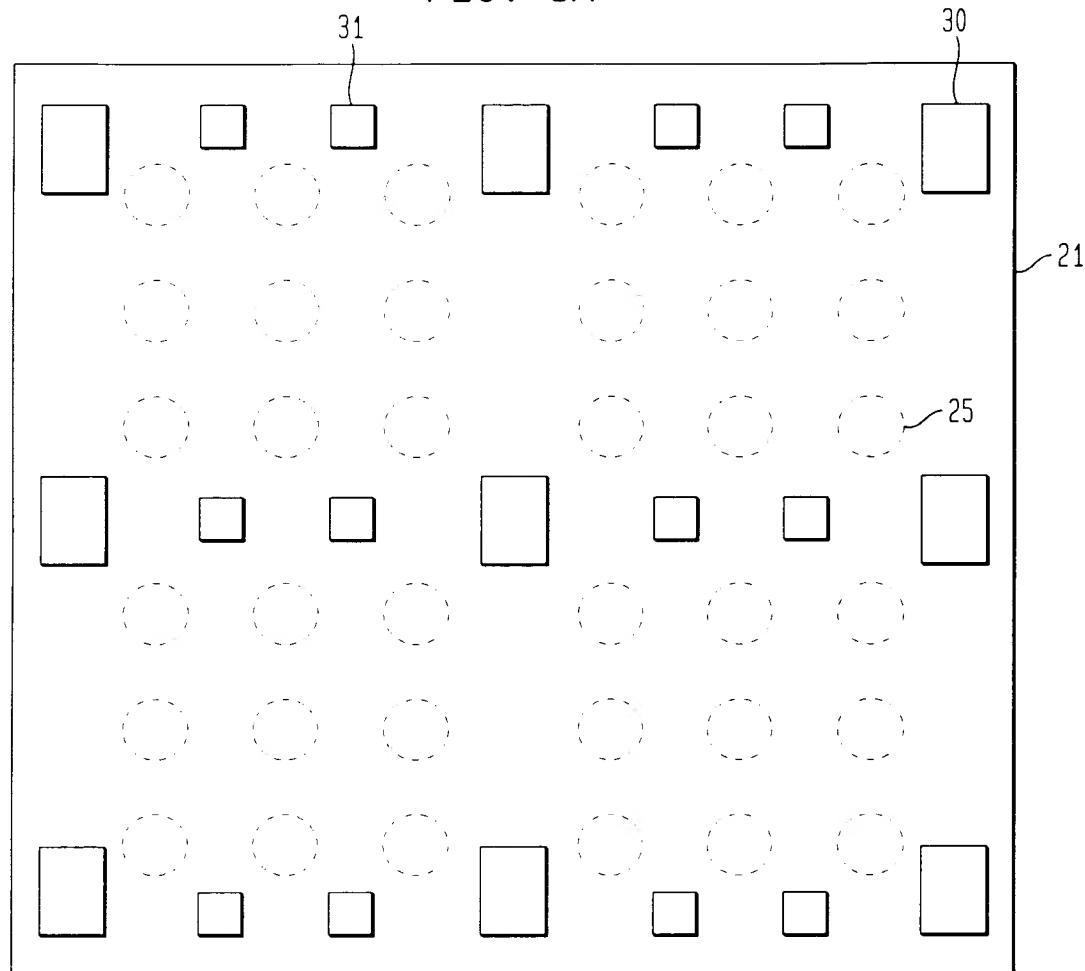
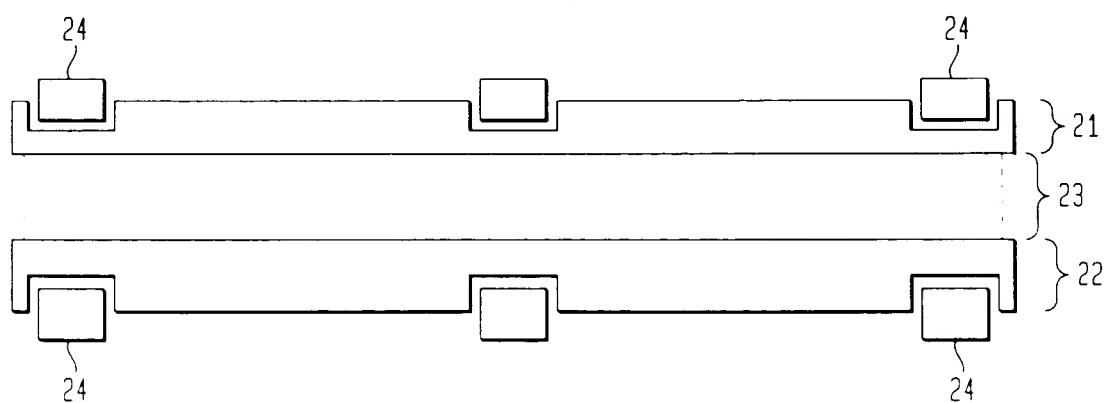


FIG. 3B



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FIG. 4A

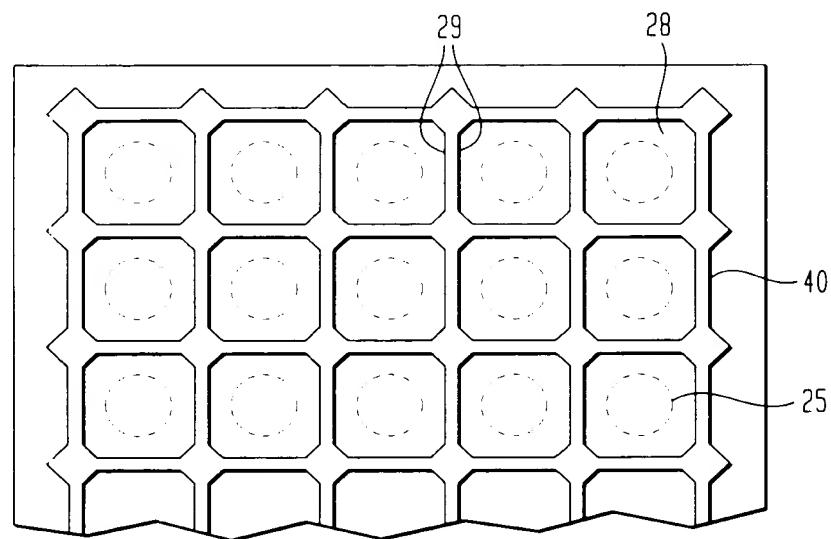


FIG. 4B

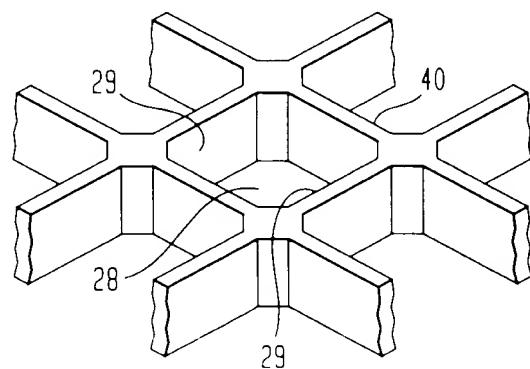
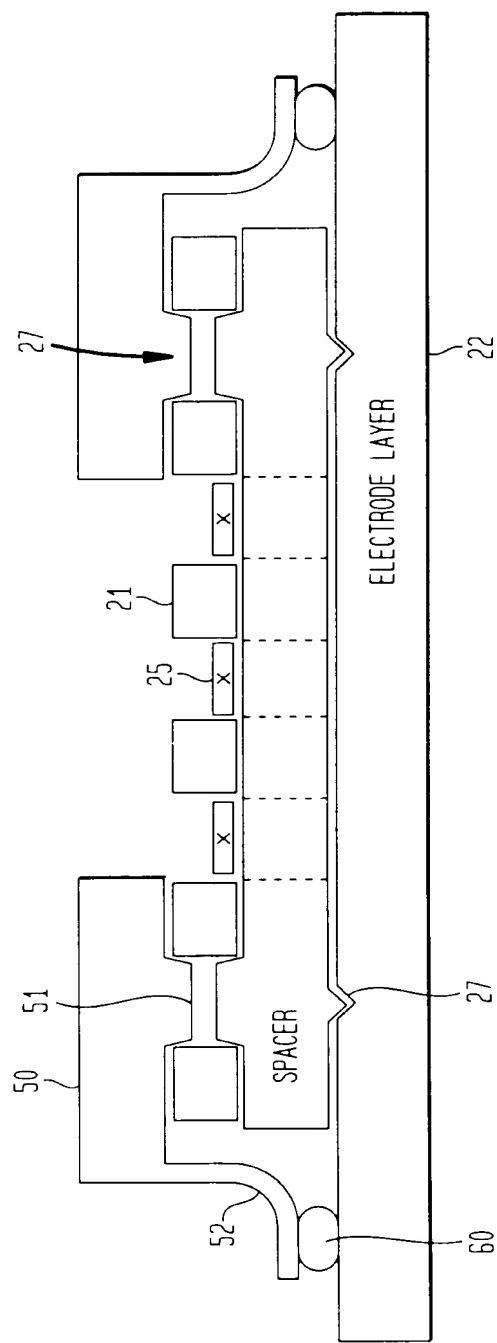


FIG. 5



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FIG. 6

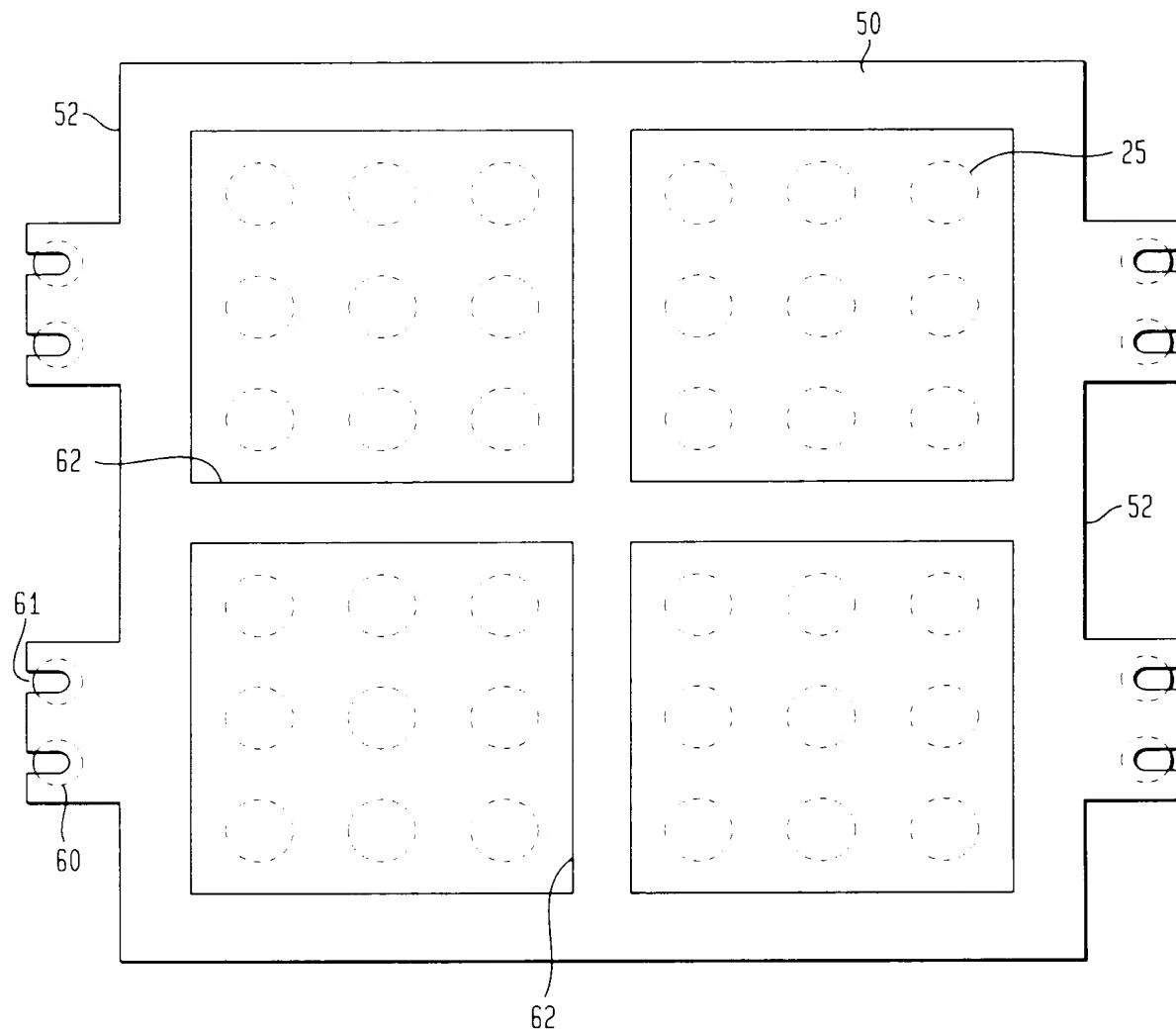
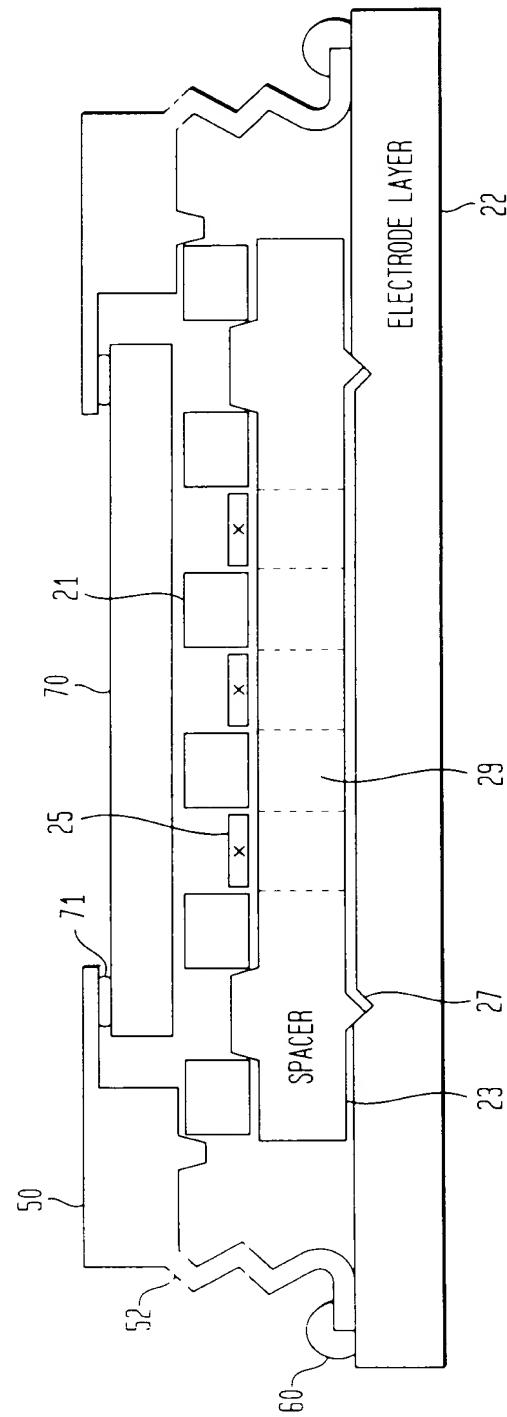


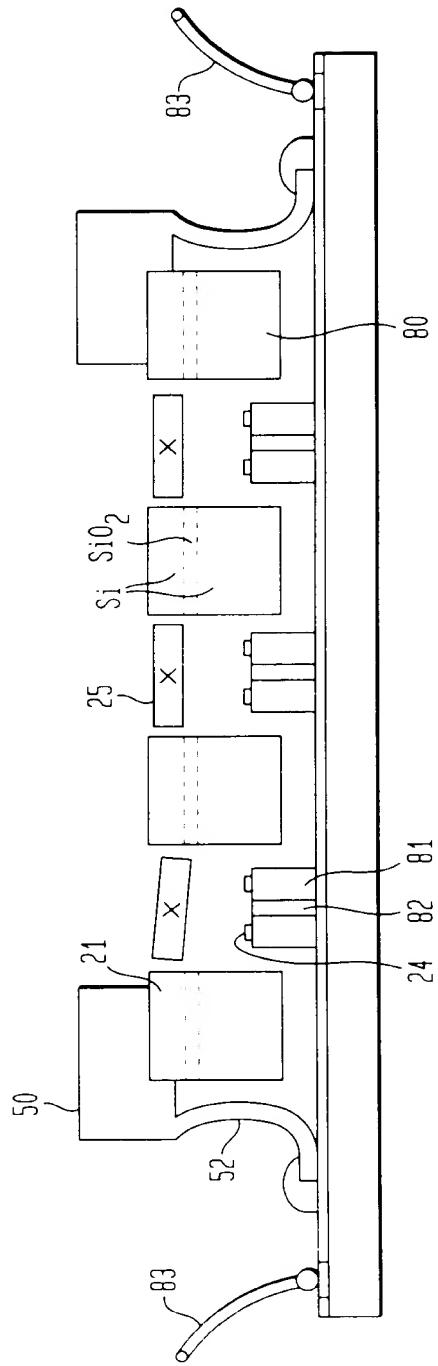
FIG. 7



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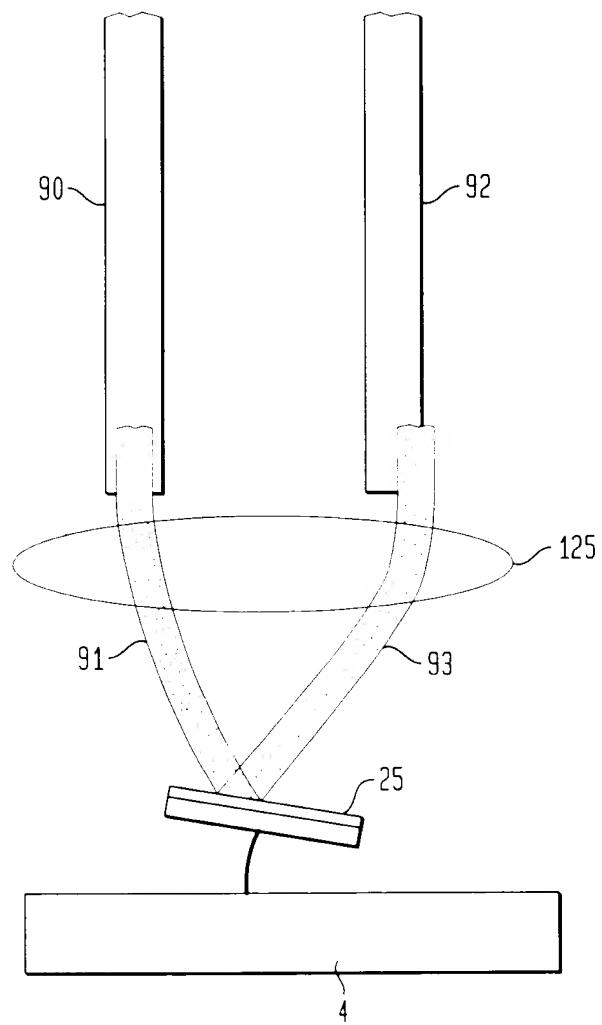
FIG. 8



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FIG. 9



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FIG. 10

